

HSF RoHS

SPECIFICATIONS

Current Rating:3.0AMP

Contact Resistance:20mΩ Max

Dielectric Strength:Min 1000V AC RMS

Operation Temperature:-40°c to +105°c

Contact Material:Copper Alloy

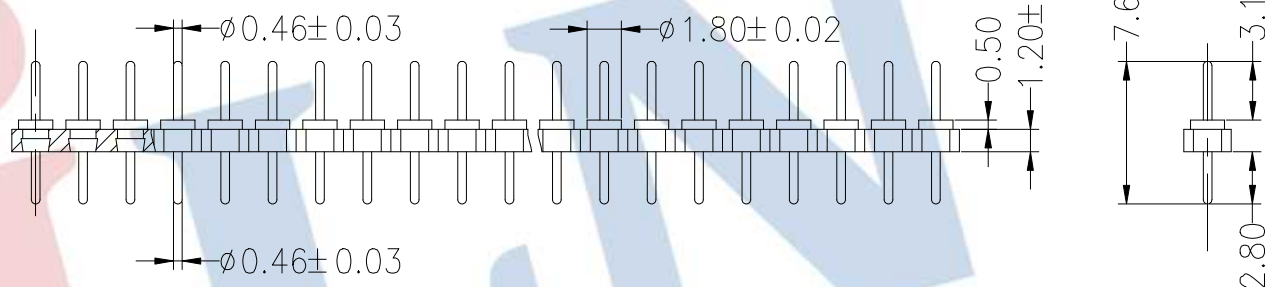
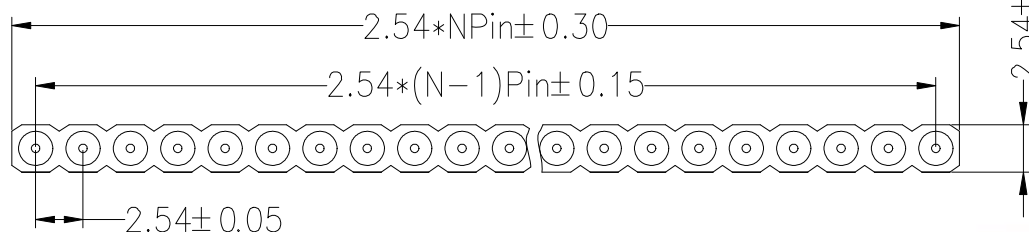
Contact Plating:Au Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: PPS

Soldering Temperature:

260°C±5°C For 5~10 Second



Ordering Information

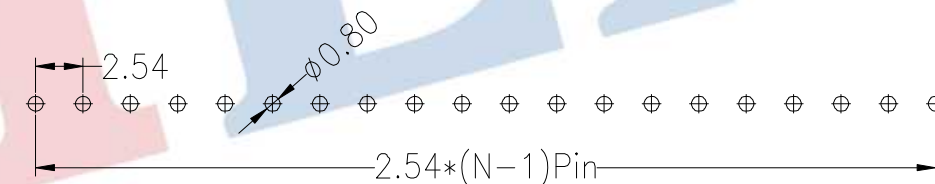
3610 12 1 XX S XX 076 XX

No. of Pins
NPin
N=02~40

Contact Plating
G1:1U" Gold
G2:1.5U" Gold
G3:2U" Gold
G4:3U" Gold
G5:5U" Gold
S0:Gold Flash/Tin
SN:Tin

Length
076=7.65mm

Code Stream



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

OPERATION

X.X ±0.30

X.XX ±0.20

X.XXX ±0.10

Angle ±3°

DIM TOL

DRAW

Jelly Feng

2023.07.11

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

1/1

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PART NO.

3610121XXSXX076XX

TITLE:

2.54X1.2单排双头针180° L7.65

A0

2023.07.11

NEW DRAWING

REV

DATE

MODIFICATION DESCRIPTION

CHANGE